
**Building environment design —
Embedded radiant heating and cooling
systems —**

**Part 3:
Design and dimensioning**

*Conception de l'environnement des bâtiments — Systèmes intégrés de
chauffage et de refroidissement par rayonnement —*

Partie 3: Conception et dimensionnement

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Foreword

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This second edition cancels and replaces the first edition (ISO 11855-3:2012), which has been technically revised.

The main changes compared to the previous edition are as follows:

- the Scope clause was modified, series-related information has been moved to the Introduction section;
- normative references were modified;
- informative references have been moved to the Bibliography;
- [Annex A](#) was added for the calculation of the thermal resistance of the insulating layers.

A list of all parts in the ISO 11855 series can be found on the ISO website.

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